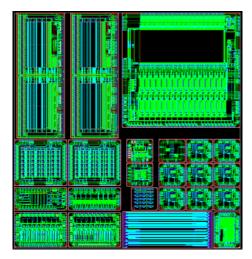
EUDET-MICELEC Status Report August 2007

A. Marchioro / CERN-PH

MICELEC Support Activities

Technology

Course Design Tools



Technology access

- Foundry contract for 130 and 90 nm CMOS and BiCMOS is available for all HEP community
- Present total demand from community is below threshold to organize internal MPWs
 - But mini-MPWs (10-25 mm²) in 130 nm are organized through MOSIS for same foundry
- Proposal for common 130 nm MPW run:
 - February 2008
 - Run split, many options, first C4 evaluation
 - □ If interested, contact us asap !

Support services

- Small lot of 130 nm PASA (Altro front -end) chip was organized
 delivery from foundry expected 8/07
- Packaging of new PASA small production lot organized in common with other similar project (cost reduction)
 - Delivery from packaging house expected 11/07
- Packaging contract discussed with Europractice for ASE/Taiwan
 - Many standard and advanced products: DIL, Quad, BGA, Flip-Chip etc.
 - If interested, contact us!
- CERN has acquired a new advanced IC tester (Credence Sapphire)
 - Users interested in accessing this service for professional IC characterization are welcome to contact us!

Technology evaluation

- Validation of rad-tolerant high voltage CMOS for DC-DC converter or other high voltage applications
 - 2A, 24 V transistor designed is now available.
- Appropriate (common) packaging solution for power applications needs to be found

Tools and Training

- Customized design kit developed (partly) with EUDET funds to facilitate design of complex digital ICs
 - Combination of foundry kit, digital library and Cadence into a coherent design environment
 - Package delivered for distribution to CERN in February 2007
 - Package installed in 5 HEP Institutes
 - Maintenance contract established to support (continuous) releases of design kit updates

Four training courses with 10 participants each

Conclusions

- CERN will continue to provide support for EUDET and in general the whole HEP community using advanced CMOS technologies
- Community is warmly recommended not to spread (the thin resources) over different technologies!
- Users are welcome to submit suggestions and comments on their wishes and needs, and foremost to report about their own experience gained using these technologies